

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KAZUTO YAMAGATA	11/12/2019
HIRONOBU MACHINAGA	11/15/2019
ERI UEDA	11/12/2019
HIROICHI UKEI	11/11/2019
TAKEHIRO UI	11/08/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	NITTO DENKO CORPORATION
<b>Street Address:</b>	1-2, SHIMOHOSUMI 1-CHOME
<b>City:</b>	IBARAKI-SHI, OSAKA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	567-8680
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16621066
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	P191243US00
<b>NAME OF SUBMITTER:</b>	YOLIDIA A. PASOS
<b>SIGNATURE:</b>	/YOLIDIA A. PASOS/
<b>DATE SIGNED:</b>	12/10/2019
<b>Total Attachments: 2</b>	

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Docket No.

### ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. Kazuto YAMAGATA residing at c/o NITTO DENKO CORPORATION, 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan and a citizen of Japan
2. Hironobu MACHINAGA residing at c/o NITTO DENKO CORPORATION, 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan and a citizen of Japan
3. Eri UEDA residing at c/o NITTO DENKO CORPORATION, 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan and a citizen of Japan
4. Hiroichi UKEI residing at c/o NITTO DENKO CORPORATION, 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan and a citizen of Japan
5. Takehiro UI residing at c/o NITTO DENKO CORPORATION, 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on \_\_\_\_\_, entitled ELECTROMAGNETIC WAVE ABSORBER AND ELECTROMAGNETIC WAVE ABSORBER-ATTACHED MOLDED ARTICLE, and which has been given application serial number \_\_\_\_\_;

and

WHEREAS NITTO DENKO CORPORATION (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and

interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Kazuo Yamagata  
Signature

November 12, 2019  
Date

Hironobu Machinaga  
Signature

November 15, 2019  
Date

Eri Ueda  
Signature

November 12, 2019  
Date

Hiroichi Ukei  
Signature

November 11, 2019  
Date

Takahiro Ise  
Signature

November 8, 2019  
Date